

FDP045N10A_F102 / FDI045N10A_F102 N-Channel PowerTrench[®] MOSFET 100V, 164A, 4.5mΩ

Features

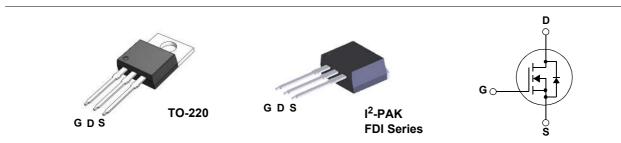
- R_{DS(on)} = 3.8mΩ (Typ.)@ V_{GS} = 10V, I_D = 100A
- · Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Application

- DC to DC Converters
- Synchronous Rectification for Telecommunication PSU
- Battery Charger
- · AC motor drives and Uninterruptible Power Supplies
- Off-line UPS



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol		Parameter		FDP045N10A_F102 FDI045N10A_F102	Units	
V _{DSS}	Drain to Source Voltage			100	V	
V _{GSS}	Gate to Source Voltage	Gate to Source Voltage				
ID		- Continuous (T _C = 25 ^o C, Silicon Limite	ed)	164*		
	Drain Current	- Continuous (T _C = 100°C, Silicon LIm	ited)	116	A	
		- Continuous (T _C = 25 ^o C, Package Lin	nited)	120		
I _{DM}	Drain Current	- Pulsed (N	lote 1)	656	А	
E _{AS}	Single Pulsed Avalanche Energy	lote 2)	637	mJ		
dv/dt	Peak Diode Recovery dv/dt (Note 3)			6.0	V/ns	
P _D	Deven Diacia etian	$(T_{\rm C} = 25^{\rm o}{\rm C})$		263	W	
	Power Dissipation	- Derate above 25 ^o C		1.75	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +175	°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

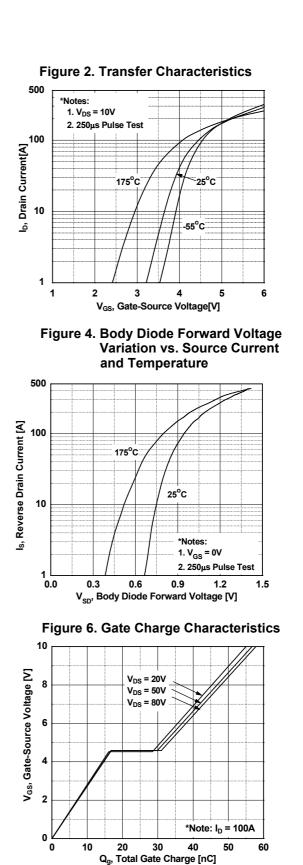
*Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 120A.

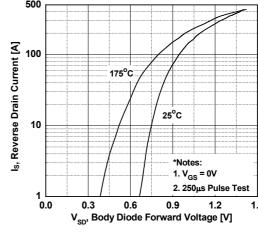
Thermal Characteristics

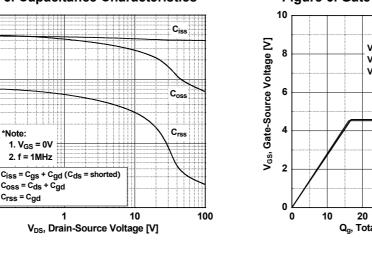
Symbol	Parameter	Ratings	Units	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	0.57	°C/W	
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient	62.5		

July 2011

Device Ma	rking	Device	Packag	le	Reel Size	Тар	e Width		Quantit	у
		FDP045N10A_F102	TO-220	- D		-		50		
FDI045N	10A	FDI045N10A_F102	I2PAK		-		-		50	
lectrica	Char	acteristics T _c = 2	25ºC unless o	otherwise no	oted					
Symbol		Parameter		Т	est Conditions	;	Min.	Тур.	Max.	Units
off Charac	teristic	S								
3V _{DSS}	Drain to	o Source Breakdown Vo	ltage	I _D = 250μA	, V _{GS} = 0V		100	-	-	V
BV _{DSS} ∆TJ	Breakdown Voltage Temperature Coefficient		re	$I_D = 250 \mu A$, Referenced to $25^{\circ}C$			-	0.07	-	V/ºC
				V _{DS} = 80V	V _{GS} = 0V		-	-	1	
DSS	Zero G	ate Voltage Drain Currei	nt		T _C = 150°C		-	-	500	
GSS	Gate to	Body Leakage Current		$V_{GS} = \pm 20^{\circ}$	V, V _{DS} = 0V		-	-	±100	
on Charact	eristic	S								
/ _{GS(th)}		hreshold Voltage		V _{GS} = V _{DS}	, I _D = 250μA		2.0	-	4.0	V
RDS(on)		Drain to Source On Resi	stance	V _{GS} = 10V			-	3.8	4.5	mΩ
IFS	Forwar	d Transconductance		$V_{DS} = 10V$		(Note 4)	-	132	-	S
) Dynamic C	haract	eristics							1	1
	T	apacitance		V _{DS} = 50V, V _{GS} = 0V f = 1MHz			-	3960	5270	pF
20SS	Output	Capacitance				-	925	1230	pF	
rss	•	e Transfer Capacitance				-	34	-	pF	
C _{oss} (er)		Releted Output Capacita	nce	V _{DS} = 50V	, V _{GS} = 0V		-	1520	-	pF
Q _{g(tot)}	0,	ate Charge at 10V		$V_{GS} = 10V, V_{DS} = 50V$			-	57	74	nC
\hat{g}_{gs}		Source Gate Charge		I _D = 100A	, 03		-	17	-	nC
 2 _{gs2}		harge Threshold to Plate	eau			-	8	-	nC	
Q _{gd}		Drain "Miller" Charge				(Note 4, 5)	-	13	-	nC
witching	harac	teristics		_1			L		1	
d(on)	1	n Delay Time					-	23	56	ns
r		n Rise Time		$V_{DD} = 50V, I_D = 100A$ $V_{GS} = 10V, R_{GEN} = 4.7\Omega$			-	26	62	ns
d(off)	Turn-Of	f Delay Time					-	50	110	ns
f		f Fall Time		1		(Note 4, 5)	-	15	40	ns
ESR	Equival	ent Series Resistance (G-S)	Drain Oper	n, f = 1MHz	,	-	1.9	-	Ω
)rain-Sour	ce Dio	de Characteristics								
s		m Continuous Drain to S		e Forward C	urrent		-	-	164*	A
s SM		m Pulsed Drain to Sour					-	-	656	A
/ _{SD}		Source Diode Forward					-	-	1.3	V
<u>т</u>		e Recovery Time	U -	$V_{GS} = 0V, I_{SD} = 100A$ $V_{GS} = 0V, V_{DD} = 50V, I_{SD} = 100A$ $dI_F/dt = 100A/\mu s \qquad (Note -1)$		= 100A	-	75	-	ns
		e Recovery Charge				(Note 4)	-	120	-	nC
. L = 3mH, I_{AS} = 2 . $I_{SD} \le$ 100A, di/dt . Pulse Test: Pulse	: Pulse widt 0.6A, R _G = 2 ≤ 200A/μs, ⁷ • width ≤ 300	h limited by maximum junction t 25Ω , Starting T _J = 25°C $V_{DD} \le BV_{DSS}$, Starting T _J = 25°C $J\mu$ s, Dual Cycle $\le 2\%$ perating Temperature Typical C	2	<u> </u> al _F /at = 10	JA/µS	(Note 4)	-	120	-	nC

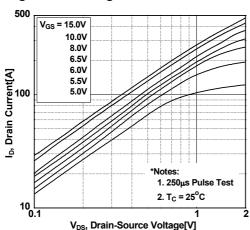


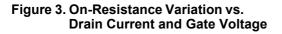


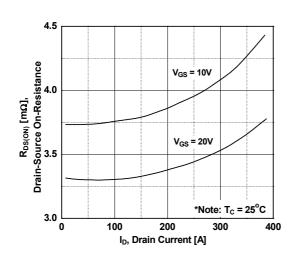


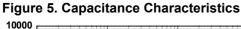
Typical Performance Characteristics

Figure 1. On-Region Characteristics









*Note

C_{rss} = C_{gd}

1000

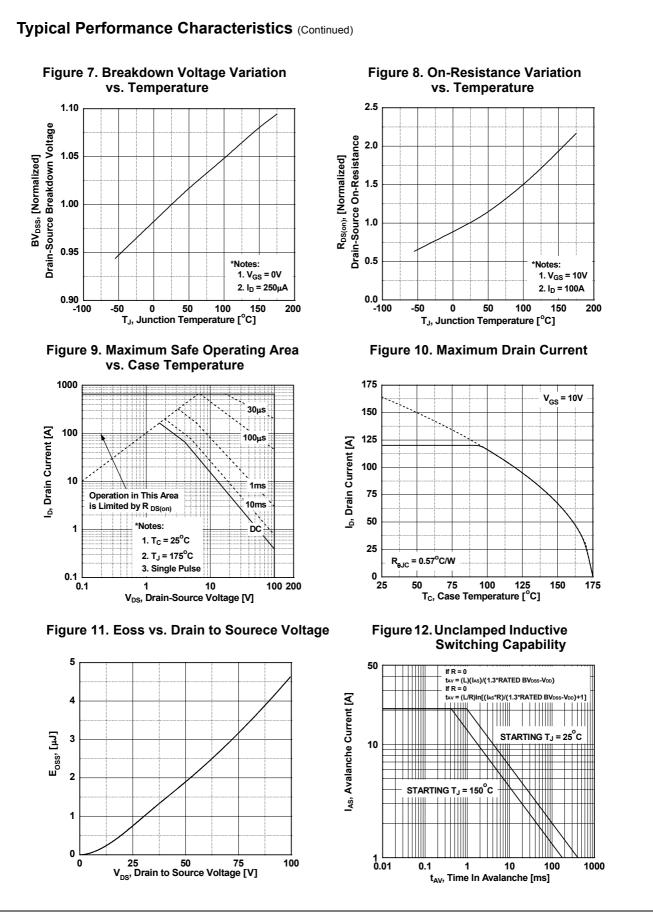
100

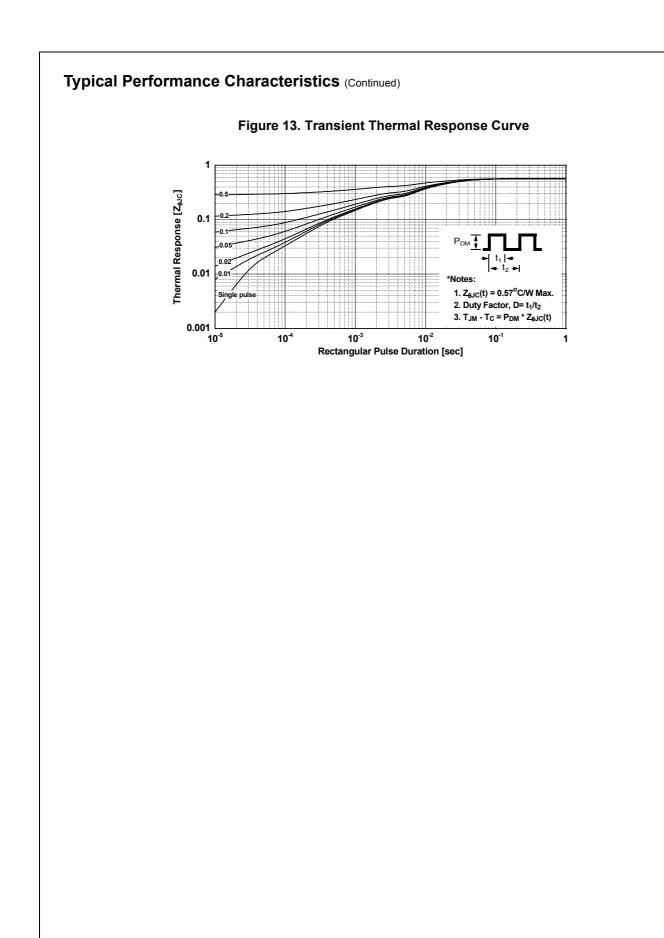
10

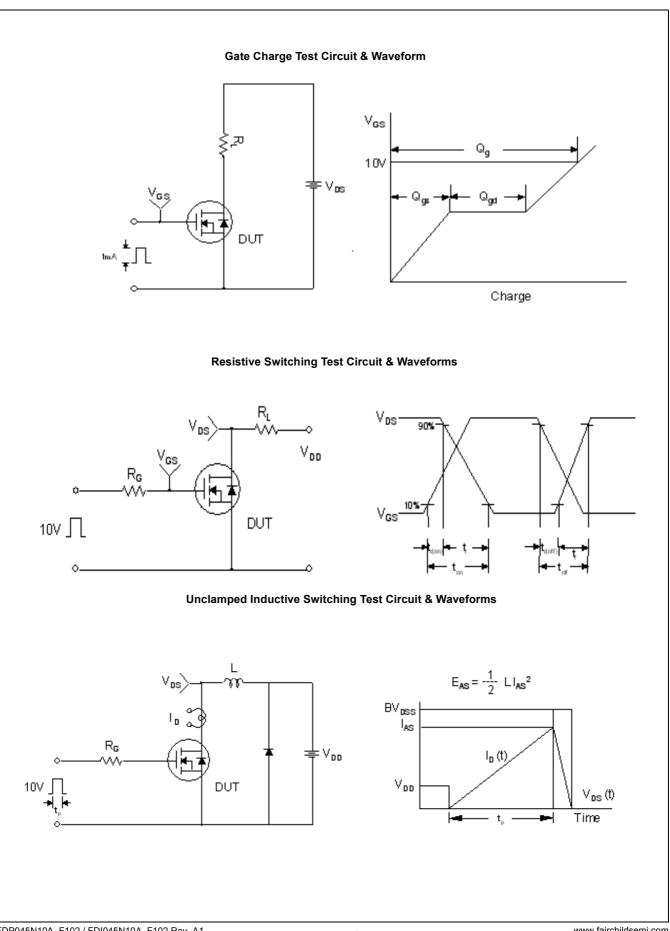
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Capacitances [pF]

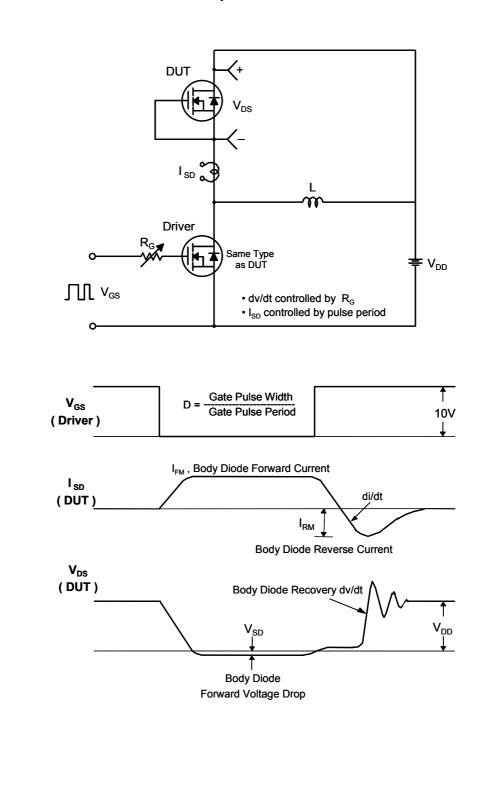
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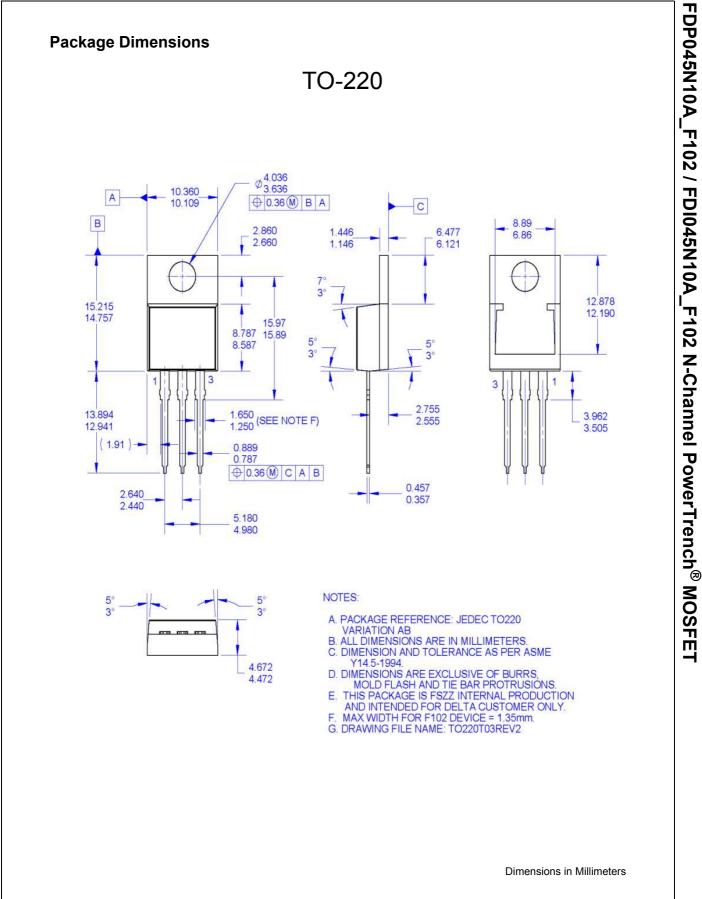




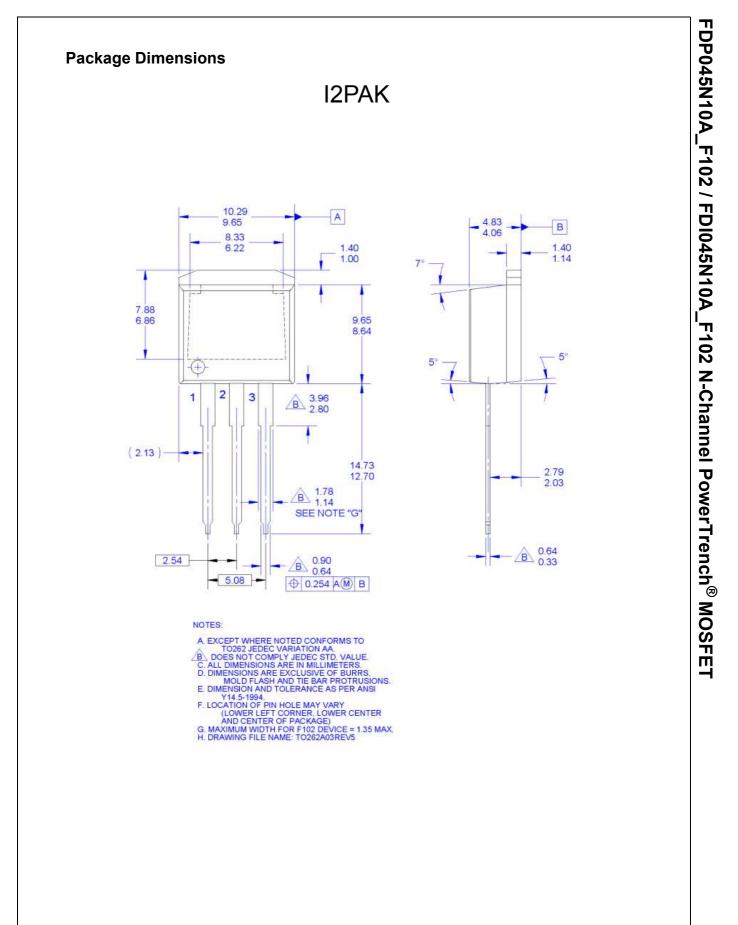


Peak Diode Recovery dv/dt Test Circuit & Waveforms





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